## 502643612 01/21/2014

## PATENT ASSIGNMENT COVER SHEET

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ATTORNEY DOCKET NUMBER:

NAME OF SUBMITTER:

Signature:

Date:

EPAS ID: PAT2690220

SUBMISSION TYPE	≣:	NEW ASSIGNMENT		
NATURE OF CONV	EYANCE:	ASSIGNMENT	ASSIGNMENT	
CONVEYING PART	Y DATA			
Name Execution Da				
Hsin-Ming Hou			01/13/2014	
Ji-Fu Kung			12/17/2013	
RECEIVING PARTY	/ DATA			
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PROPERTY NUMB	ERS Total: 1			
Property Type		Number		
Application Number: 1		14159657		
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PATENT 502643612 REEL: 032008 FRAME: 0301

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JUSTIN KING

/Justin King/

01/21/2014

	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 2 source=DA#page1.tif source=DA#page2.tif	

PATENT REEL: 032008 FRAME: 0302

	Serial No. Docket No.
,	Ref. No. UMCD-2013-0450 Sundial Ref. No. US10234PA

## Combined Declaration and Assignment for Patent Application

For the subject matter which is claimed and for which a patent is sought on the invention entitled:

STACKED SEMICONDUC SAME	CTOR STRUCTURE AND MANUFACTURING METHOD FOR THE
I hereby declare that: As a below name	ned inventor
The specification of which is attr	ached hereto unless the following box is checked
🔲 was filed on	
as United States Application Nu	mber or PCT International Application Number
I believe I am the original invent	was made or authorized to be made by me. or or an original joint inventor of a claimed invention in the application. If talse statements made in this statement is punishable under 18 U.S.C. 1001 by fine or/and live (5) years.
	ASSIGNMENT
WHEREAS, I(we), the named in Assignor.	rventor(s), whose post office address(es) appear(s) below, hereinafter referred to as
	3. Li-Hein Rd.B, Heinchu Science Park, Talwan 30078, ROC. IEE, is desirous of acquiring the entire right, title and interest in and to the same in the United

NOW. THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged. I (we), Assignon, by these presents do sell, assign and transfer unto said Assignee, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part, and reissue of said application for the full term or terms for which the same may be granted, including all priority rights under any international Convention.

ASSIGNOR further coverants that no assignments, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

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PATENT REEL: 032008 FRAME: 0303

Serial No.
Attorney Docket No.
Ref. No. UMCD-2913-0450
Sundial Hef. No. US 10234PA

ALSO. Assiction hereby agrees to execute any documents that legally may be required in connection with the filling protecution and maintenance of said application or any other patent application(s) in the United States for said Invention modeling additional documents that may be required to affirm the rights of Assiches in and to said leven took all valencing to required to assign agrees, without further consideration and at Assigned's expense, to identify and communicate to Assigned's request decuments and information concerning that twinnion that are within Assigned's possession or control, and to provide further assurances and testimony on behalf of Assigness that tewfully may be required of Assigned in respect of the prospection, maintenance, litigation and defense of any patent application or betall encompassed within the terms of this Instrument. Assigned's obligations under this instrument shall extend to Assigned's heirs, executors ariministrators and other legal representatives.

ALSO, Assistion hereby euthorizes and requests this Commissioner of Patents and Trademarks to issue any and all Letters Parent referred to above to Assistate, as the Assistate of the entire right, title and interest in and to the same, for Assistate's sole use and behoof, and for the use and behoof of Assistate's legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by Assistan had this assignment and sale not been made.

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